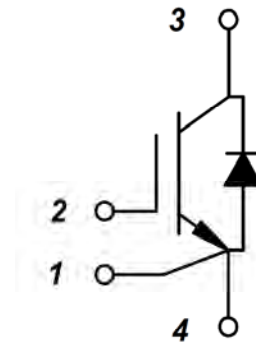


PRODUCT FEATURES

- ☐ High short circuit capability, self limiting short circuit current
- ☐ IGBT CHIP(T4 Fast Trench+Field Stop technology)
- ☐ $V_{CE(sat)}$ with positive temperature coefficient
- ☐ Fast switching and short tail current
- ☐ Free wheeling diodes with fast and soft reverse recovery
- ☐ Low switching losses
- ☐ Popular SOT-227 Package



APPLICATIONS

- ☐ High frequency switching application
- ☐ Medical applications
- ☐ Motion/servo control
- ☐ UPS systems

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J = 25^\circ\text{C}$	1200	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C = 25^\circ\text{C}$	100	A
		$T_C = 95^\circ\text{C}$	75	
I_{CM}	Repetitive Peak Collector Current	$t_p = 1\text{ms}$	150	
P_{tot}	Power Dissipation Per IGBT		468	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J = 25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current	$T_C = 25^\circ\text{C}$	75	A
I_{FRM}	Repetitive Peak Forward Current	$t_p = 1\text{ms}$	150	
I^2t		$T_J = 125^\circ\text{C}$, $t = 10\text{ms}$, $V_R = 0\text{V}$	1150	A^2S

IGBT-inverter

ELECTRICAL CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
V _{GE(th)}	Gate Emitter Threshold Voltage	V _{CE} =V _{GE} , I _C =3mA	5.4	6.0	6.5	V	
V _{CE(sat)}	Collector Emitter Saturation Voltage	I _C =75A, V _{GE} =15V, T _J =25℃		2.1	2.5		
		I _C =75A, V _{GE} =15V, T _J =125℃		2.5			
I _{CES}	Collector Leakage Current	V _{CE} =1200V, V _{GE} =0V, T _J =25℃			1	mA	
		V _{CE} =1200V, V _{GE} =0V, T _J =125℃			10	mA	
I _{GES}	Gate Leakage Current	V _{CE} =0V,V _{GE} =±15V, T _J =25℃	-400		400	nA	
R _{gint}	Integrated Gate Resistor			10		Ω	
Q _g	Gate Charge	V _{CE} =600V, I _C =75A , V _{GE} =15V		0.35		μC	
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V, f =1MHz		4.4		nF	
C _{res}	Reverse Transfer Capacitance			240		pF	
t _{d(on)}	Turn on Delay Time	V _{CC} =600V,I _C =75A R _G =10Ω, V _{GE} =±15V, Inductive Load	T _J =25℃		150	ns	
			T _J =125℃		160	ns	
			T _J =150℃		170	ns	
t _r	Rise Time		T _J =25℃		60	ns	
			T _J =125℃		65	ns	
			T _J =150℃		70	ns	
t _{d(off)}	Turn off Delay Time	T _J =25℃		360	ns		
		T _J =125℃		400	ns		
		T _J =150℃		420	ns		
t _f	Fall Time	T _J =25℃		40	ns		
		T _J =125℃		60	ns		
		T _J =150℃		70	ns		
E _{on}	Turn on Energy	V _{CC} =600V,I _C =75A R _G =10Ω, V _{GE} =±15V, Inductive Load	T _J =125℃		10	mJ	
			T _J =150℃		11	mJ	
E _{off}	Turn off Energy		T _J =125℃		4.5	mJ	
			T _J =150℃		4.8	mJ	
I _{sc}	Short Circuit Current		tpsc≤10μS , V _{GE} =15V T _J =125℃,V _{CC} =600V		300		A
R _{thJC}	Junction to Case Thermal Resistance （ Per IGBT ）				0.32	K /W	

Diode-inverter

ELECTRICAL CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V _F	Forward Voltage	I _F =75A , V _{GE} =0V, T _J =25℃		1.65	2.15	V
		I _F =75A , V _{GE} =0V, T _J =125℃		1.65		
t _{rr}	Reverse Recovery Time	I _F =75A , V _R =600V dI _F /dt=-1650A/μs T _J =125℃		450		ns
I _{RRM}	Max. Reverse Recovery Current			65		A
Q _{RR}	Reverse Recovery Charge			13.5		μC
E _{rec}	Reverse Recovery Energy			5.1		mJ
R _{thJCD}	Junction to Case Thermal Resistance （ Per Diode ）				0.6	K /W

MODULE CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature		175	$^\circ\text{C}$
T_{Jop}	Operating Temperature		-40~150	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
Torque	to heatsink	Recommended (M4)	0.7~1.1	Nm
	to terminal	Recommended (M4)	0.7~1.1	Nm
Weight			26.5	g

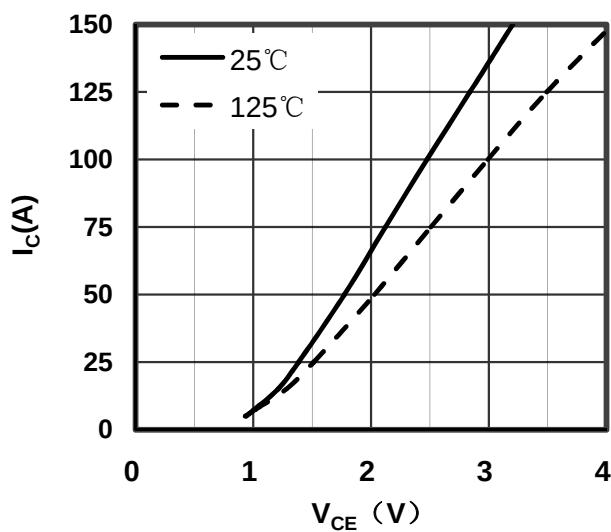


Figure 1. Typical Output Characteristics IGBT-inverter

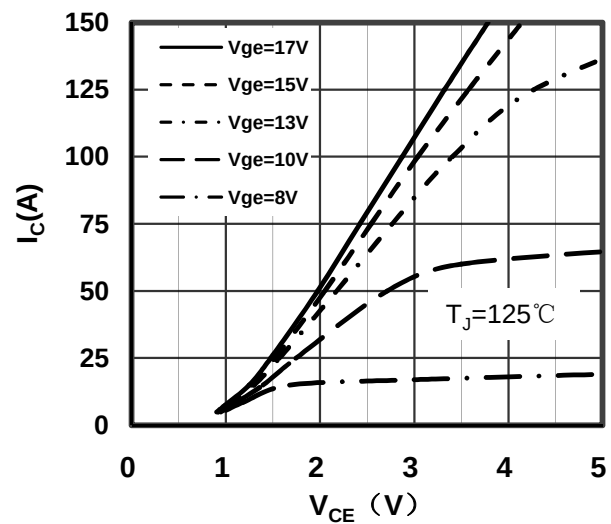


Figure 2. Typical Output Characteristics IGBT-inverter

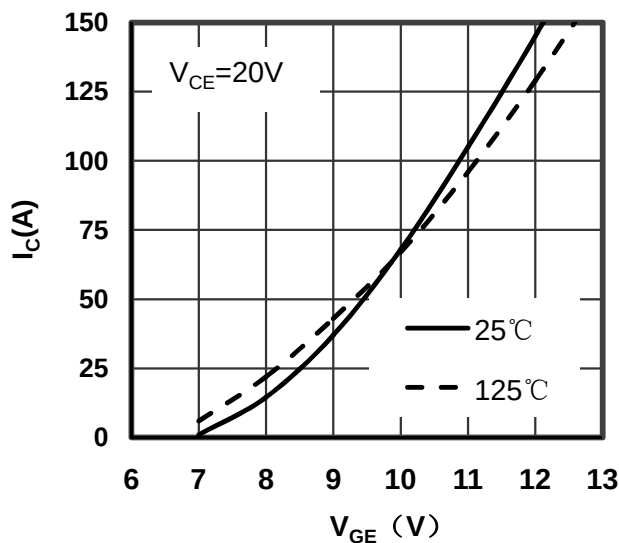


Figure 3. Typical Transfer characteristics IGBT-inverter

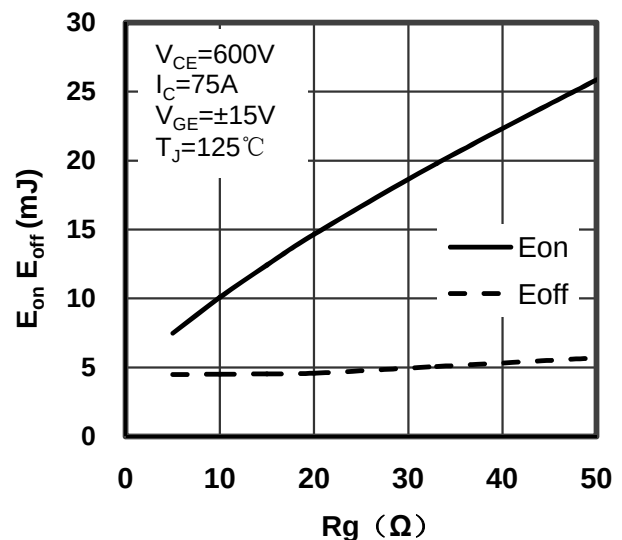


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

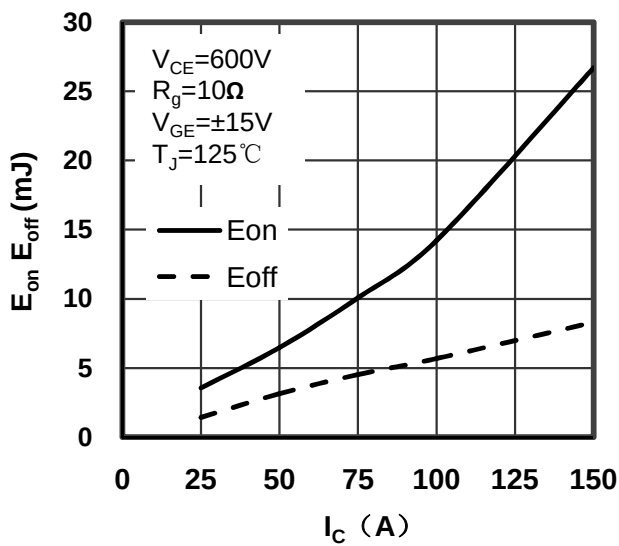


Figure 5. Switching Energy vs Collector Current
IGBT-inverter

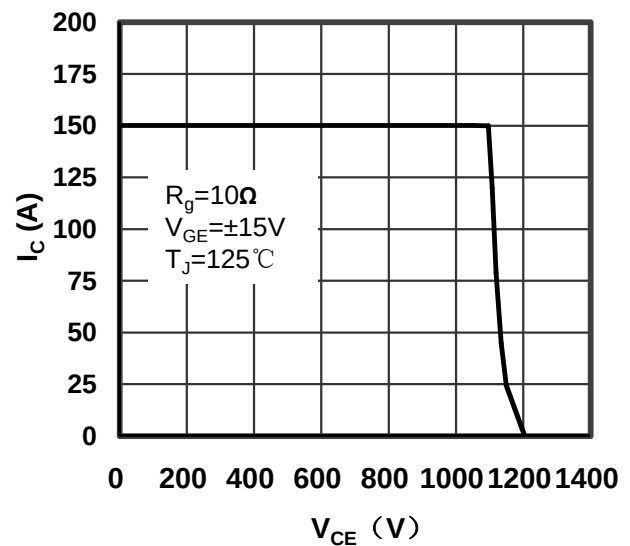


Figure 6. Reverse Biased Safe Operating Area
IGBT-inverter

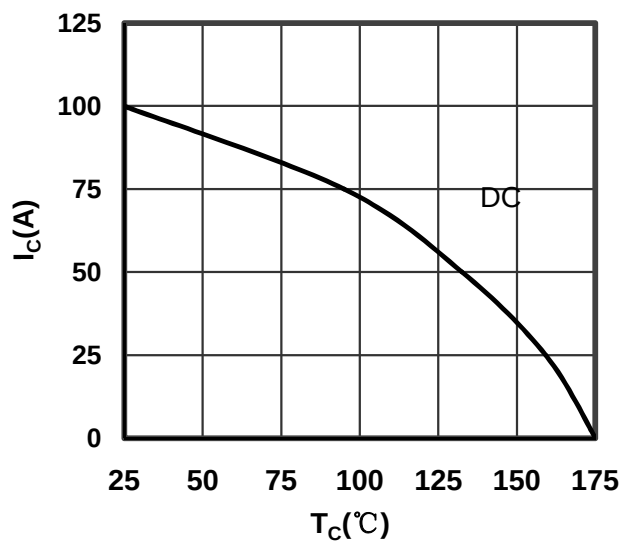


Figure 7. Collector Current vs Case temperature
IGBT -inverter

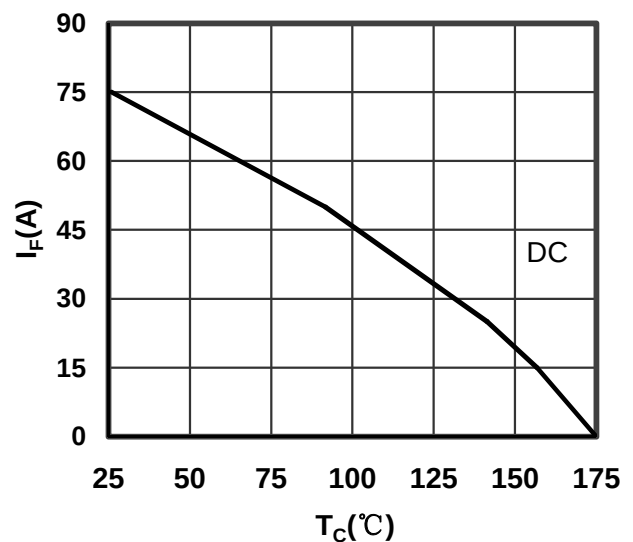


Figure 8. Forward current vs Case temperature
Diode -inverter

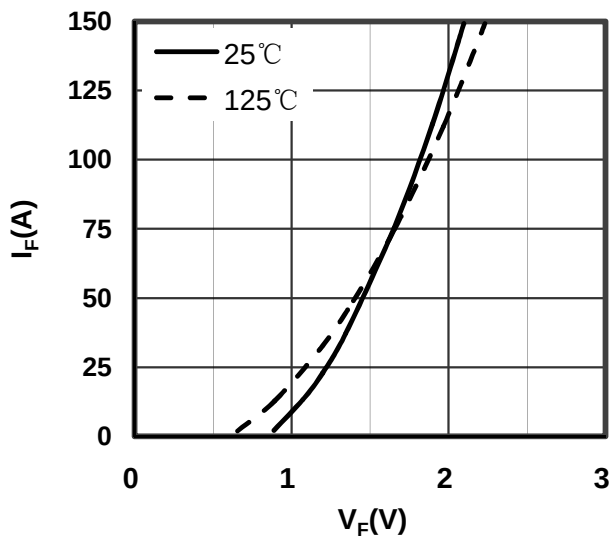


Figure 9. Diode Forward Characteristics
Diode -inverter

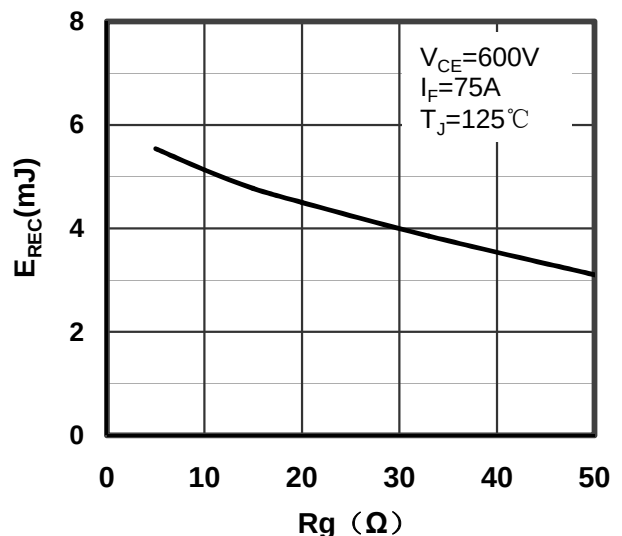


Figure 10. Switching Energy vs Gate Resistor
Diode -inverter

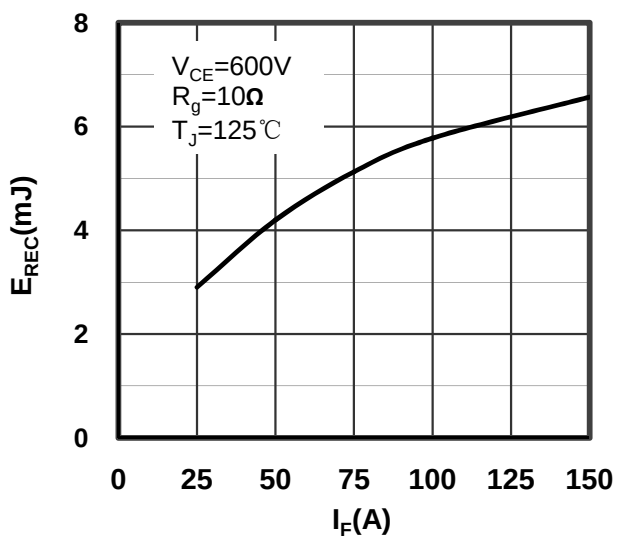


Figure 11. Switching Energy vs Forward Current
Diode-inverter

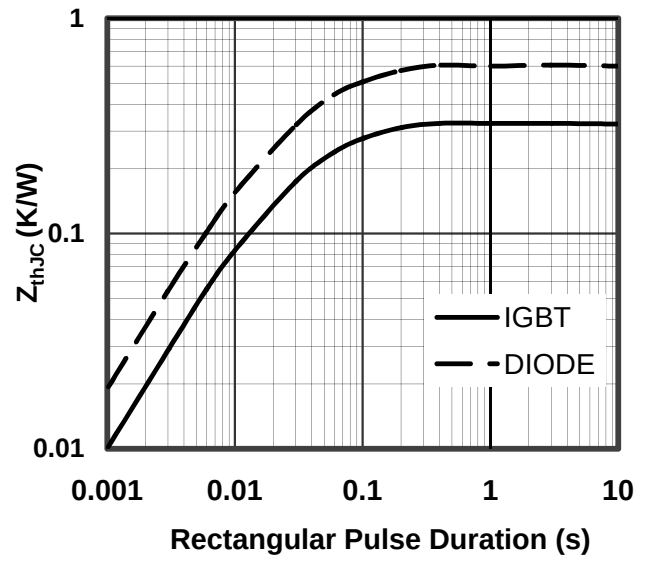
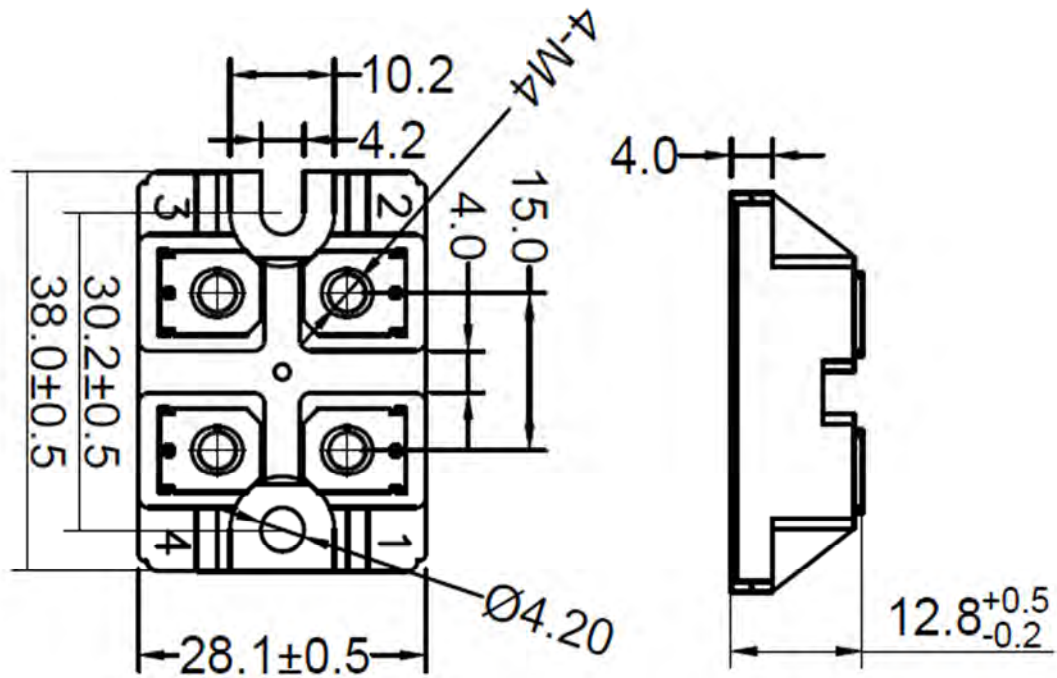


Figure 12. Transient Thermal Impedance of
Diode and IGBT-inverter



Dimensions in (mm)
Figure 13. Package Outline